# SMART ULTRA-LOW POWER IMU BMI270 OPTIMIZED FOR WEARABLES

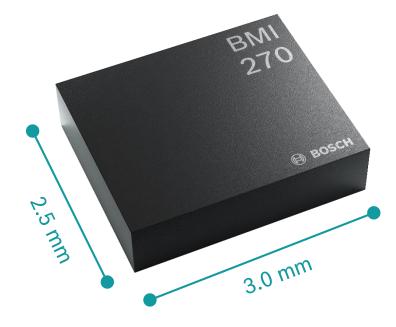




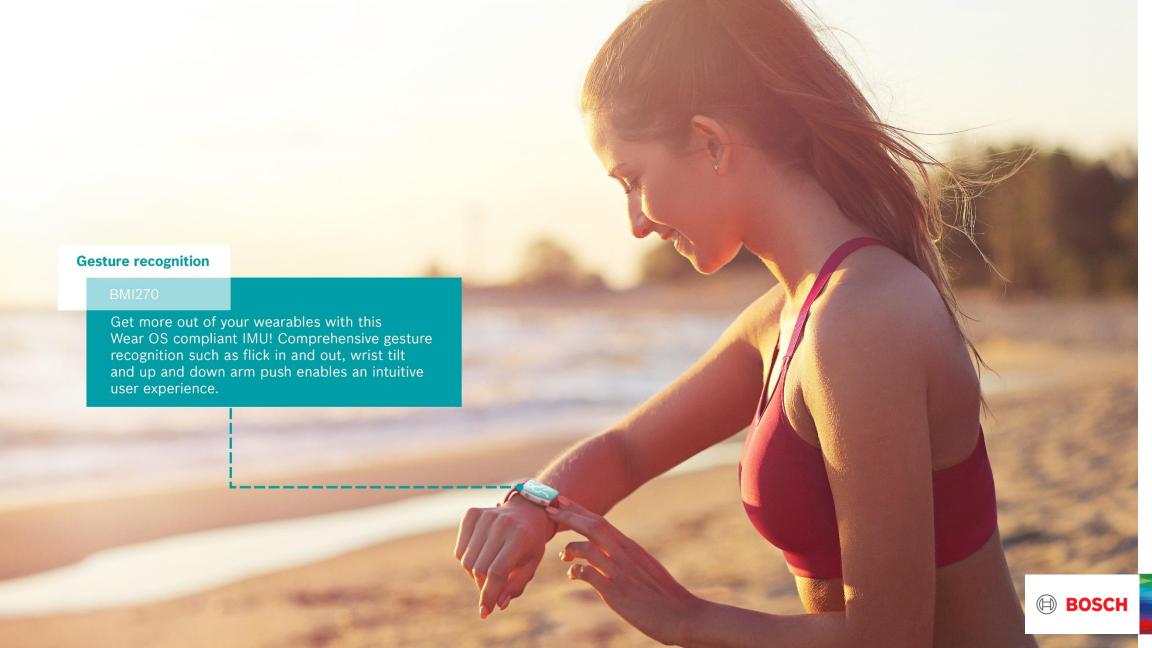
# Smart ultra-low power IMU optimized for wearables

The BMI270 is a smart ultra-low power IMU optimized for wearable and hearable applications.

- Includes intuitive activity, context and gesture recognition.
- Compact package of 3.0  $\times$  2.5  $\times$  0.8 mm<sup>3</sup>.









# Overview devices and applications

#### Wearable devices:

- ► Fitness trackers, wrist bands, smartwatches
- ► Hearables and head-worn devices
- ► Ankle bands, neck bands
- ► Smart clothes

#### **Applications:**

- ► Always-on
  - ► Step counting
  - ► Gesture recognition
  - ► Activity recognition
  - ► Context recognition













► Technical features BMI270



## **Technical features**



BMI270

Ultra-low power smart IMU for wearables

#### Application-specific versions: gesture & context/activity

Includes Wear OS features: flick in/out, arm up/down, wrist tilt and advanced features for recognizing context and activity change

#### **Significant power reduction**

Intelligent power management unit enables always-on features to run inside the ultra-low power domain of the IMU

#### Self-calibrating gyroscope

Features industry's first self-calibrating gyroscope using motionless CRT (Component Re-Trimming) functionality

#### Wide range of target devices

Fitness trackers, wristbands, smartwatches, hearables, ankle bands, neck bands, smart clothes, augmented and virtual reality glasses and controllers

#### Improved step counter/detector

Integrated plug-and-play step counter/detector optimized for wristworn devices

#### Integrated state-of-the-art MEMS sensors

16-bit accelerometer and 16-bit gyroscope

#### **Package dimensions**

3.0 x 2.5 x 0.8 mm³ (14-pin) LGA package



# **Technical features**

Parameter	BMI270
Dimensions	3.0 mm x 2.5 mm x 0.8 mm
Typ. current consumption Accelerometer only (LPM) Advanced features A+G suspend mode	685 μA (at full ODR) 10 μΑ ~3 35 μA (depending on feature set) 5.5 μΑ
Sensitivity error	(A): ± 0.4% (G): ± 0.4% (with CRT)
Max. ODR	(A): 1.6 kHz (G): 6.4 kHz
Noise density	(A): 160 μg/√Hz (G): 0.008 dps/√Hz
Offset vs PCB strain	(A): ±0.01 mg/με (G): ±1.5 mdps/με

Typical target values, values will be verified in final qualification

